MODEL NO.: TS022GAACB05-00

ISSUED DATE: 2008-02-01

VERSION: Ver 1.0

■Preliminary Specification □Final Product Specification

Customer	•
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Approved by	Notes

SHANGHAI TIANMA Confirmed:

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2008-02-01	2008-02-01	2008-02-01			

This technical specification is subjected to change without notice





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Record of Revision

Rev	Issued Date	Description
1.0	2008-02-01	Preliminary Release



General specifications

	Fe	eature	Spec	
	Size		2.2"	
	Resolutio	n	176(RGB) X 220	
	Interface		CPU 18/8 bit	
	Color Dep	oth	262K/65K	
	Technolog	gy type	a-si TFT	
Diaplay Spec	Pixel pitch	n (mm)	0.198x0.198	
Display Spec.	Pixel Con	figuration	R.G.B. Vertical Stripe	
	Display M	lode	TM with Normally White	
	Surface T	reatment(Up Polarizer)	Clear type (3H)	
	Surface T	reatment(Up TSP)	Clear type (3H)	
	Viewing D	Direction	6 o'clock	
	Gray Scale Direction		12 o'clock	
	DIM.	LCM (W x H x D) (mm)	41.7x56.16x3.6	
Maabaaiaal	Active Are	ea(mm)	34.848x43.56	
Mechanical Characteristics	With /With	nout TSP	WITH TSP	
2.14.45.5.151100	Weight (gram)		TBD.	
	LED Num	bers	3 LEDs (in parallel)	
Electronic	Driver IC		NT39115	

Note 1: Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2: Requirements on Environmental Protection: RoHS



2 Input/Output terminals

2.1 TFT LCD Panel

No	Symbol	I/O	Description	Remark
1	GND	Р	Ground	
2	VDD	Р	Power Supply	
3	VDD	Р	Power Supply	
4	CS	I	Chip selection	
5	RS	I	Read signal Read:rising edge(/WR='1')	
6	WR	I	Write signal Write:rising edge(/RD='1')	
7	RD	I	Read signal Active low	
8	DB0	I	Data Bus	
9	DB1	I	Data Bus	
10	DB2	I	Data Bus	
11	DB3	I	Data Bus	
12	DB4	I	Data Bus	
13	DB5	I	Data Bus	
14	DB6	ı	Data Bus	
15	DB7	ı	Data Bus	
16	DB8	I	Data Bus	
17	DB9	ı	Data Bus	
18	DB10	ı	Data Bus	
19	DB11	I	Data Bus	
20	DB12	I	Data Bus	
21	DB13	ı	Data Bus	
22	DB14	ı	Data Bus	
23	DB15	ı	Data Bus	
24	RESET	I	Reset signal Active low	
25	IM0	I	Date mode select	Note 2-2
26	GND	Р	Ground	
27	YD	0	Touch Panel signal: Down	
28	XL	0	Touch Panel signal: Left	
29	YU	0	Touch Panel signal: Up	
30	XR	0	Touch Panel signal: Right	
31	LED_K1	Р	Led Power	Note 2-3
32	LED_K2	Р	Led Power	Note 2-3
33	LED_K3	Р	Led Power	Note 2-3
34	LED_A	Р	Led Power	Note 2-3

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Note2-1: I/O definition:

I----Input

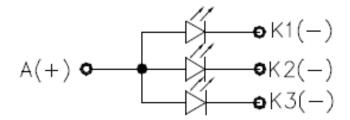
O---Output

P----Power

Note2-2: Data mode select:

IM0	Interface	DB pin
1	8080 MCU 8-bit Parallel	DB17~10
0	8080 MCU 16-bit Parallel	DB17~10;DB8~1

Note2-3: Figure below shows the connection of backlight LED.







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3 Absolute maximum ratings

3.1 Driving TFT LCD Panel

 $Ta = 25^{\circ}C$

Item	Symbol	MIN	MAX	Unit	Remark
Supply Voltage	VDD	-0.3	4.6	٧	
Input Signal Voltage	VIN	-0.3	VDD +0.3	٧	
Back Light Forward Current	I _{LED}		25	mA	For each LED
Operating Temperature	T_OPR	-20	70	$^{\circ}$	
Storage Temperature	T _{STG}	-30	80	$^{\circ}$ C	_

4 Electrical characteristics

4.1 Driving TFT LCD Panel

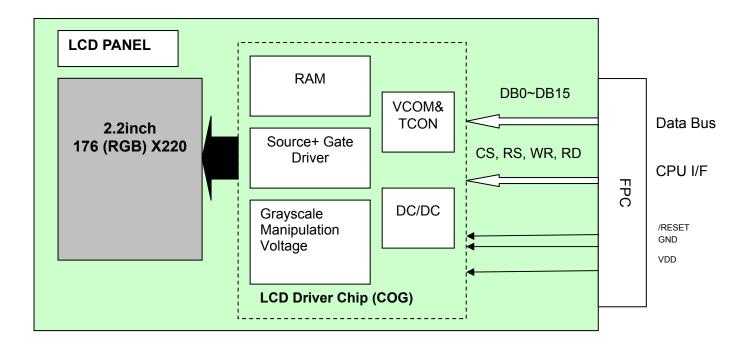
GND=0V, Ta=25℃

Item		Symbol	MIN	TYP	MAX	Unit	Remark
Supply Voltage		VDD	2.7	2.8	2.9	V	
Input Signal	Low Level	VIL	0	1	0.2*VDD	٧	DB0~DB15,CS,RS,WR,
Voltage	High Level	VIH	0.8*VDD	1	VDD	٧	RD,RESET
Output Signal	Low Level	Vol	-	1	0.3*VDD	٧	
Voltage	High Level	Vон	0.7*VDD		VDD	٧	
	,		1	TBD	1	mW	
(Panel+ LSI) Power Consumption		Standby Mode	1	TBD	-	mW	
		Sleeping Mode		TBD		mW	

4.2 Driving Backlight Ta=25℃

Item	Symbol	MIN	TYP	MAX	Unit	Unit
Forward Current	I _F		20	25	mA	For each LED
Forward Voltage	V_{F}		3.2		V	3 LEDs
Power Consumption	W _{BL}		192		mW	(in parallel)

4.3 Block Diagram



5 Timing chart

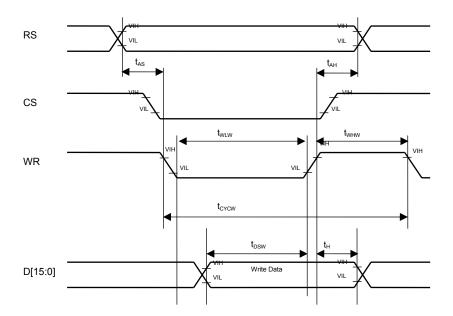
5.1 8080 MCU system

5.1.1 8080 MCU system timing parameter

Normal Write Mode (VCC=2.5~3.3V)

	Item	Symbol	Unit	Min.	Тур.	Max.	Test Condition
Bus cycle time	t _{CYCW}	ns	100	-	-		
Write low-level pul	t _{WLW}	ns	35	-	-		
Write high-level pu	t _{WHW}	ns	35	-	-		
Setup time	t _{AS}	ns	10	-			
Address hold time	t _{AH}	ns	10	-	-		
Write data set up t	t _{DSW}	ns	10	-	-		
Write data hold tin	t _H	ns	10	-	-		

5.1.2 8080 MCU system bus timing





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TS022GAACB05-00

5.1.3 8080 MCU system interface with 8-bit data bus

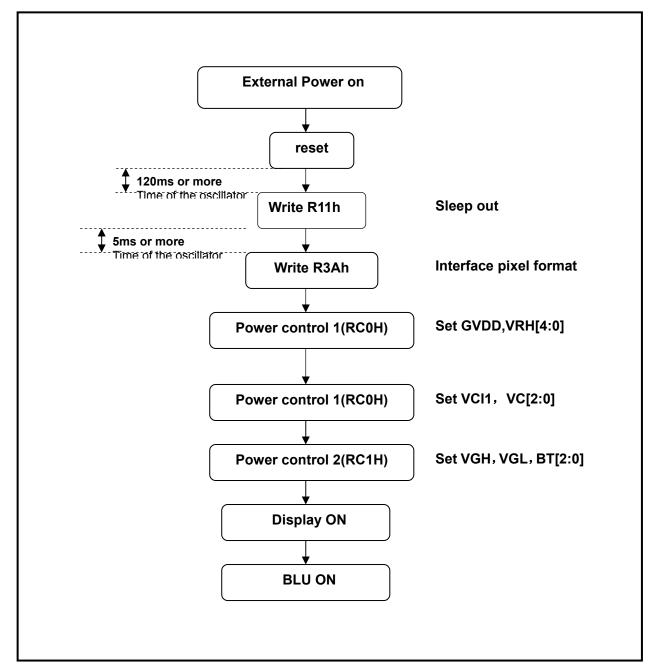
Registe	Register		DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Register
Comma	nd	0	0	1	0	1	1	0	0	х	х	х	х	х	х	х	х	х	х	2Ch
IFPF[2:	0]	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Colour
		R3	R2	R1	R0	G3	G2	G1	G0	х	x	x	х	×	×	х	x	x	x	
011	3	В3	B2	B1	B0	R3	R2	R1	R0	х	х	х	х	х	х	х	х	х	х	4K-Colour (2-pixels/ 3-byyes)
		G3	G2	G1	G0	В3	B2	B1	В0	х	х	х	х	х	х	х	х	х	х	(2-pixeis/ 3-byyes)
101	5	R4	R3	R2	R1	R0	G5	G4	G3	х	х	х	х	х	х	х	х	х	х	65K-Colour
101	5	G2	G1	G0	В4	B3	B2	B1	В0	х	x	х	х	x	х	х	х	х	х	(1-pixels/ 2-byyes)
		R5	R4	R3	R2	R1	R0	х	х	х	х	х	х	х	х	х	х	х	х	262K-Colour
110	6	G5	G4	G3	G2	G1	G0	x	x	x	х	х	х	x	х	х	х	х	x	(1-pixels/ 3byyes)
		B5	B4	В3	B2	B1	В0	x	x	x	x	x	x	x	×	х	x	x	x	1. big 20,3c3

5.1.4 8080 MCU system interface with 8-bit data bus

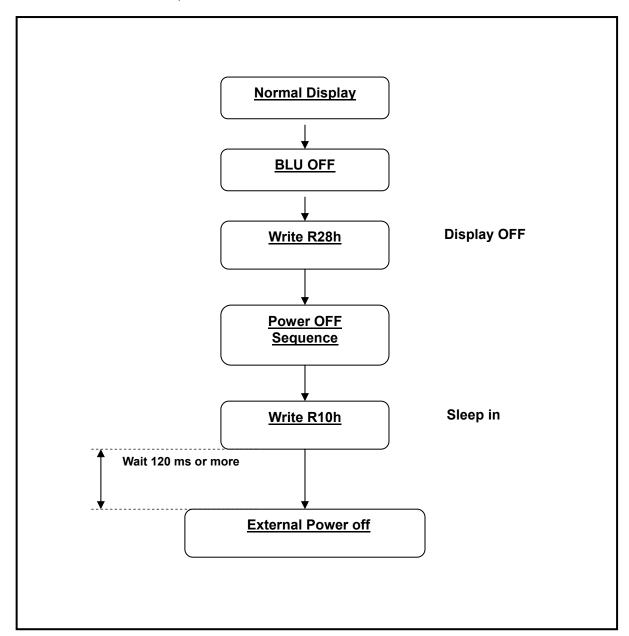
Regi	Register		B17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Register
Comn	mand		х	х	х	х	х	х	х	х	×	0	0	1	0	1	1	0	0	x	2Ch
IFPF	[2:0]	DI	B17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Colour
011	3		x	х	х	х	R3	R2	R1	R0	х	G3	G2	G1	G0	В3	B2	B1	В0	х	4K-Colour
101	5	-	R4	R3	R2	R1	R0	G5	G4	G3	x	G2	G1	G0	B4	В3	B2	B1	B0	х	65K-Colour
		F	R5	R4	R3	R2	R1	R0	х	х	х	G5	G4	G3	G2	G1	G0	х	х	х	2021/ 0-1
110	6	E	B5	B4	В3	B2	B1	B0	х	х	х	R5	R4	R3	R2	R1	R0	х	х	х	262K-Colour (2-pixels/3byyes)
		0	35	G4	G3	G2	G1	G0	х	х	х	B5	B4	В3	B2	B1	B0	х	х	х	(E-pixeis/ obyyes)

5.2 Power On/Off sequence

5.2.1 Power on Sequence



5.2.2 Power off Sequence



6 Optical characteristics

6.1 Optical Specification

Ta=25°C

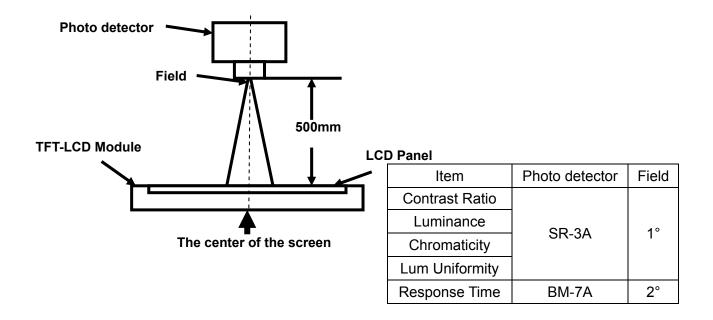
Item		Symbol	Condition	Min	Тур.	Max.	Unit	Remark	
		⊖Т		35	40	-			
Viou Angloo		⊖В	CD>10	15	20	-	Dograd	Note 2	
View Angles		θL	CR≧10	40	45	-	Degree		
		θ R		40	45	-			
Contrast Ratio		CR	θ=0°	200	350	1		Note1 Note3	
Response Tim	e	Ton	25 ℃	_	25	40	ms	Note1	
reopenee min		Toff	200		20	10	1110	Note4	
	White	Х		0.26	0.30	0.36		Note5, Note1	
	VVIIILE	у		0.28	0.33	0.38			
	RED	x		0.57	0.62	0.67			
Chromoticity	NLD	у	Brightness	0.28	0.33	0.38			
Chromaticity	GREEN	Х	is on	0.25	0.30	0.35			
	GREEN	у		0.54	0.59	0.64			
	BLUE	х		0.08	0.13	0.18			
	BLUE	у		0.07	0.12	0.17			
Uniformity		U		75	80	-	%	Note1 Note6	
NTSC				-	60	-	%	Note 5	
Luminance		L		150	200	-	cd/m ²	Note1 Note7	

Test Conditions:

- 1. Vcc=2.8V, I_L=20mA(Backlight current), the ambient temperature is 25℃.
- 2. The test systems refer to Note 1 and Note 2.

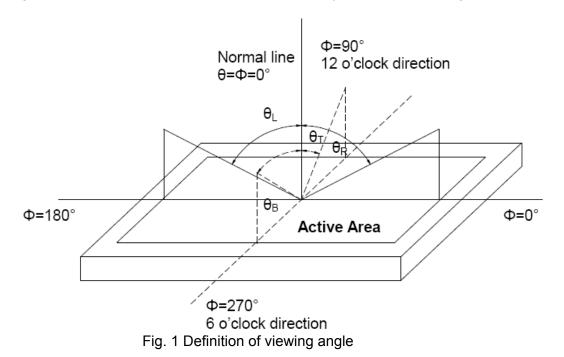
Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).



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Note 3: Definition of contrast ratio

 $\mbox{Contrast ratio (CR)} = \frac{\mbox{Luminance measured when LCD is on the "White" state}}{\mbox{Luminance measured when LCD is on the "Black" state}}$

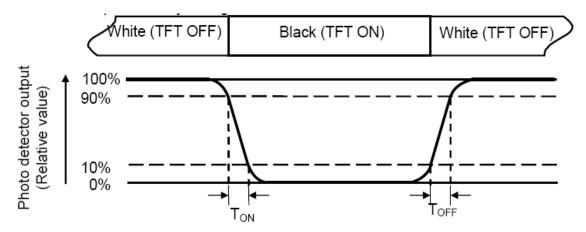
"White state ": The state is that the LCD should driven by Vwhite.

"Black state": The state is that the LCD should driven by Vblack.

Vwhite: To be determined Vblack: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/Lmax

L-----Active area length W----- Active area width

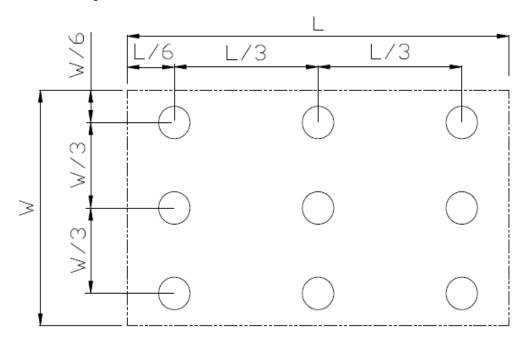


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.

7 Environmental / Reliability tests

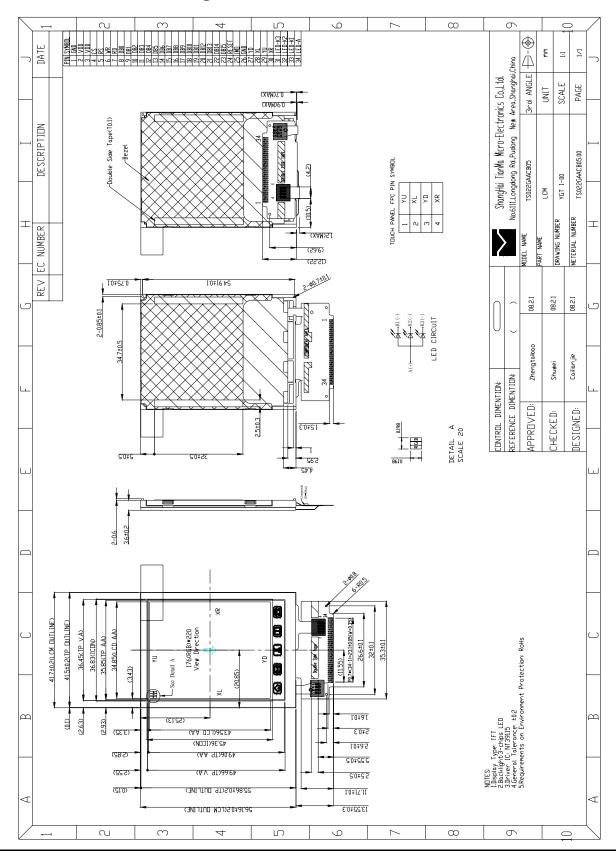
No	Test Item	Condition	Remarks				
1	High Temperature (Operation)		Note1 IEC60068-2-2,GB2423.2—89				
2	High Temperature & High Humidity (Storage)	Ta=+60℃, 90% RH Max 240 hours	Note2 IEC60068-2-3, GB/T2423.3—2006				
3	Low Temperature (Operation)	1a=-20 C, 240nrs	IEC60068-2-1 GB2423.1—89				
4	High Temperature (Storage)	Ta=+70℃, 240hrs	IEC60068-2-2, GB2423.2—89				
5	Low Temperature (Storage)	Ta=-30℃, 240hrs	IEC60068-2-1 GB2423.1—89				
6	Thermal Shock (Storage)	-30°C 30 min~+70°C 30 min, Change time:5min, 20 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22—87				
7	Electro Static Discharge (Storage)	C=150pF, R=330 Ω , 5points/panel Air:±8KV, 5times; Contact:±4KV, 5 times; (Environment: 15 $^{\circ}$ C $^{\circ}$ 35 $^{\circ}$ C, 30% $^{\circ}$ 60%, 86Kpa $^{\circ}$ 106Kpa)	IEC61000-4-2 GB/T17626.2—1998				
8	Vibration (Storage)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total)	IEC60068-2-6 GB/T2423.10—1995				
9	Shock (Storage)	60G 6ms, ±X,±Y,±Z 3times, for each direction	IEC60068-2-27 GB/T2423.5—1995				
10	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32 GB/T2423.8—1995				

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of samples.



8 Mechanical drawing







9 Packing drawing

TBD

10 Precautions for use of LCD modules

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol、
 - Ethyl alcohol
- 10.1.6 Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:
 - Water
 - Ketone
 - Aromatic solvents
- 10.1.7 Do not attempt to disassemble the LCD Module.
- 10.1.8 If the logic circuit power is off, do not apply the input signals.
- 10.1.9 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- 10.2 Be sure to ground the body when handling the LCD Modules.
- 10.3 Tools required for assembly, such as soldering irons, must be properly ground.
- 10.4 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 10.5 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
- 10.6 Storage precautions
- 10.6.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.6.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:
- 10.7 Temperature : 0°C ~ 40°C Relatively humidity: ≤80%
- 10.7.1 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.7.2 Transportation Precautions
- 10.8 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.